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12/23/2009

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EXAMINER

HANLEY, BRITT D

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PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary	Application No. 10/576,867	Applicant(s) YAMAZAKI ET AL.	
	Examiner BRITT D. HANLEY	Art Unit 2889	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 09 September 2009.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-25 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-25 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 09 September 2009 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|---|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

Art Unit: 2889

DETAILED ACTION

Response to Amendment

01. Amendment filed on 09/09/2009 has been entered and noted by Examiner. Claims 1-25 are pending.

Claim Objections

02. Claims 16 and 17 are objected to because of the following informalities: It appears that Applicant has struck through newly added claim limitations. Examiner interprets the limitations added to claims 3 and 4 to be present in claims 16 and 17 (see below). Appropriate correction is required.

03. Claims 11-13 are objected to because of the following informalities: Applicant failed to underline the newly added word "to" . Appropriate correction is required.

Drawings

04. The drawings were received on 09/09/2009. These drawings are accepted.

Claim Rejections - 35 USC § 103

05. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

06. The factual inquiries set forth in *Graham v. John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

1. Determining the scope and contents of the prior art.
2. Ascertaining the differences between the prior art and the claims at issue.
3. Resolving the level of ordinary skill in the pertinent art.
4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

Art Unit: 2889

07. Claims 1, 2, 5, 6, 7, 10, 13, 14, 15, 18, 19, 23, and 24 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki *et al.* (US 2001/0055841 A1) in view of Takao (JP 2003-058077 A) and Yamazaki *et al.* (US 6,355,941).

08. Hereinafter, Yamazaki *et al.* (US 2001/0055841 A1) is D1, Takao (JP 2003-058007 A) is D2, and Yamazaki *et al.* (US 6,355,941) is D3.

09. Regarding claims 1 and 14, D1 discloses a light emitting display device comprising: a gate electrode (339) formed over a substrate (301) having an insulating surface; a gate insulating layer (372) formed over the gate electrode; a semiconductor layer (435) and a first electrode (383) formed over the gate insulating layer (Figure 4A); a wiring layer (382) formed over the semiconductor layer (Figure 4A); a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode (Figure 4A); and a second electrode (386) over the electroluminescent layer (Figure 4A). D1 does not explicitly appear to disclose (a) a base film including substance having a photocatalytic function between the substrate and gate electrode and the gate electrode formed on the base film, or (b) the wiring layer covers the edge portion of the first electrode.

10. However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a photocatalytic surface (TiO₂) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

11. Further, in the same field of active-matrix devices, D3 discloses a wiring layer (157) covering an edge portion (Figure 4A) of a first electrode (158) in order to connect to the first electrode (paragraph 119).

12. At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the photocatalytic surface of D2 in order to simplify TFT manufacturing and to cover an edge of the first electrode with the wiring as taught by D3 in order to connect the wiring to the electrode.

Art Unit: 2889

1.3 Regarding claims 2 and 15, the D1 discloses a light emitting display device comprising: a wiring layer (382) and a first electrode (383) formed over a substrate (301) having an insulating surface; a semiconductor layer (435) formed over the wiring layer; a gate insulating layer (372) formed over the semiconductor layer; a gate electrode (339) formed over the gate insulating layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer. D1 does not explicitly appear to disclose (a) a base film including a substance having a photocatalytic function and the wiring layer and the first electrode formed on the base film, (b) the wiring layer covers the edge portion of the first electrode, or (c) the top gate TFT/ reverse staggered TFT configuration.

1.4 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a photocatalytic surface (TiO₂) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

1.5 Further, in the same field of active-matrix devices, D3 discloses a wiring layer (157) covering an edge portion (Figure 4A) of a first electrode (158) in order to connect to the first electrode (paragraph 119) and a reverse staggered TFT configuration (paragraphs 234-237, Figure 24).

1.6 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the photocatalytic surface of D2 in order to simplify TFT manufacturing and to cover an edge of the first electrode with the wiring as taught by D3 in order to connect the wiring to the electrode. Further, the use of a reverse staggered TFT is a matter of design variation known in the art.

1.7 Regarding claims 4 and 17, the D1 discloses a light emitting display device comprising: a wiring layer (382) and a first electrode (383) formed over a substrate (301) having an insulating surface; a semiconductor layer (435) formed over the wiring layer; a gate insulating layer (372) formed over the semiconductor layer; a gate electrode (339) formed over the gate insulating layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer, wherein the first electrode covers an edge portion of the wiring layer (Figure 4A). D1 does not explicitly appear to disclose (a) a base film including a substance having a photocatalytic function and the gate electrode formed on the base film, or (b) the top gate TFT/ reverse staggered TFT configuration.

Art Unit: 2889

18 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a photocatalytic surface (TiO₂) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

19 Further, in the same field of active-matrix devices, D3 discloses a reverse staggered TFT configuration (paragraphs 234-237, Figure 24).

20 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the photocatalytic surface of D2 in order to simplify TFT manufacturing and the use of a reverse staggered TFT is a matter of design variation known in the art.

21 Regarding claims 5 and 18, the combination of D1-D3 disclose a light emitting display device according to any one of claims 1 to 2 or 14-15, wherein the substance having a photocatalytic function comprises titanium oxide (D2, paragraph 12). The motivation to combine is given above.

22 Regarding claims 6 and 19, D1 discloses a light emitting display device comprising: a substrate (301) having an insulating surface, a gate electrode (339) formed over the substrate; a gate insulating layer (372) formed over the gate electrode; a semiconductor layer (435) and a first electrode (383) formed over the gate insulating layer; a wiring layer (382) formed over the semiconductor layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer. D1 does not appear to explicitly disclose (a) a conductive layer including a refractory metal over a substrate having an insulating surface, or (b) the wiring layer covers the edge portion of the first electrode.

23 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a conductive layer including a refractory metal (Ti) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

24 Further, in the same field of active-matrix devices, D3 discloses a wiring layer (157) covering an edge portion (Figure 4A) of a first electrode (158) in order to connect to the first electrode (paragraph 119).

Art Unit: 2889

25 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the conductive layer with a refractory metal of D2 in order to simplify TFT manufacturing and to cover an edge of the first electrode with the wiring as taught by D3 in order to connect the wiring to the electrode.

26 Regarding claims 7 and 20, D1 discloses a light emitting display device comprising: a substrate (301) having an insulating surface; a wiring layer (382) and a first electrode (383) formed over the substrate; a semiconductor layer (435) formed over the wiring layer; a gate insulating layer (372) formed over the semiconductor layer; a gate electrode (339) formed over the gate insulating layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer. D1 does not explicitly appear to disclose (a) a substance conductive layer including a refractory metal over a substrate having an insulating surface, (b) the wiring layer covers the edge portion of the first electrode, or (c) the top gate TFT/ reverse staggered TFT configuration.

27 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a conductive layer including a refractory metal (Ti) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

28 Further, in the same field of active-matrix devices, D3 discloses a wiring layer (157) covering an edge portion (Figure 4A) of a first electrode (158) in order to connect to the first electrode (paragraph 119) and a reverse staggered TFT configuration (paragraphs 234-237, Figure 24).

29 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the conductive layer with a refractory metal of D2 in order to simplify TFT manufacturing and to cover an edge of the first electrode with the wiring as taught by D3 in order to connect the wiring to the electrode. Further, the use of a reverse staggered TFT is a matter of design variation known in the art.

Art Unit: 2889

30 Regarding claims 9 and 22, D1 discloses a light emitting display device comprising: a substrate (301) having an insulating surface; a wiring layer (382) and a first electrode (383) formed over the substrate; a semiconductor layer (435) formed over the wiring layer; a gate insulating layer (372) formed over the semiconductor layer; a gate electrode (339) formed over the gate insulating layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer, wherein the first electrode covers an edge portion of the wiring layer (Figure 4A). D1 does not explicitly appear to disclose (a) a substance conductive layer including a refractory metal over a substrate having an insulating surface, or (b) the top gate TFT/ reverse staggered TFT configuration.

31 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a conductive layer including a refractory metal (Ti) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

32 Further, in the same field of active-matrix devices, D3 a reverse staggered TFT configuration (paragraphs 234-237, Figure 24).

33 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 to include the conductive layer with a refractory metal of D2 in order to simplify TFT manufacturing and the use of a reverse staggered TFT is a matter of design variation known in the art.

34 Regarding claims 10 and 23, the combination of D1-D3 discloses a light emitting display device according to any one of claims 6-9 or 19-22 wherein the refractory metal is selected from the group consisting of Ti (titanium), W (tungsten), Cr (chromium), Al (aluminum), Ta (tantalum), Ni (nickel), Zr (zirconium), Hf (hafnium), V (vanadium), Ir (iridium), Nb (niobium), Pd (lead), Pt (platinum), Mo (molybdenum), Co (cobalt), and Rh (rhodium) (D2, paragraph 12). The motivation to combine is given above.

35 Regarding claims 11 and 24, the combination of D1-D3 discloses a light emitting display device according to any one of claims 1-4, 6-9, 14-17, and 19-22, wherein the gate electrode and the wiring layer are made of a material selected from the group consisting of silver, gold, copper, and indium tin oxide (D3, Cu, paragraph 145). At the time the invention was made, it would have been obvious to a person having ordinary skill in the art to use a metal such as copper, gold, or ITO in order to reduce electrical resistance or form a transparent electrode. Further, these are all well known electrode materials in the art.

Art Unit: 2889

3.6 Regarding claim 13, the combination of D1-D3 disclose a TV set including a display screen having the light emitting display device according to any one of claims 1-2 and 6-7 (D1, Figure 18A).

3.7 Regarding claims 12 and 25, the combination of D1-D3 disclose the light emitting display device according to any one of claims 1-4 and 6-9, wherein the semiconductor layer is a semi-amorphous semiconductor containing hydrogen and halogen and having a crystal structure (column 8, lines 31-46, D3). At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D3 to modify the device of D1 and D2 to include the semiconductor layer comprising a semi-amorphous semiconductor containing hydrogen and halogen and having a crystal structure of D3 in order to improve TFT operation (column 8, D3).

3.8 Claims 3, 8, 16, and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki *et al.* (US 2001/0055841 A1) in view of Takao (JP 2003-058077 A).

3.9 Regarding claims 3 and 16, D1 discloses a light emitting display device comprising: a gate electrode (339) formed over a substrate (301) having an insulating surface; a gate insulating layer (372) formed over the gate electrode; a semiconductor layer (435) and a first electrode (383) formed over the gate insulating layer (Figure 4A); a wiring layer (382) formed over the semiconductor layer (Figure 4A); a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode (Figure 4A); and a second electrode (386) over the electroluminescent layer (Figure 4A), wherein the first electrode covers an edge portion of the wiring layer (Figure 4A). D1 does not explicitly appear to disclose (a) a base film including a substance having a photocatalytic function formed on the substrate and (b) the gate electrode formed on the base film.

4.0 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a photocatalytic surface (TiO₂) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

4.1 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D2 to modify the device of D1 to include the photocatalytic surface of D2 in order to simplify TFT.

Art Unit: 2889

4.2 Regarding claims 8 and 21, D1 discloses a light emitting display device comprising: a substrate (301) having an insulating surface, a gate electrode (339) formed over the substrate; a gate insulating layer (372) formed over the gate electrode; a semiconductor layer (435) and a first electrode (383) formed over the gate insulating layer; a wiring layer (382) formed over the semiconductor layer; a partition wall (384) covering an edge portion of the first electrode and the wiring layer; an electroluminescent layer (385) over the first electrode; and a second electrode (386) over the electroluminescent layer, wherein the first electrode covers an edge portion of the wiring layer (Figure 4A). D1 does not appear to explicitly disclose (a) a conductive layer including a refractory metal over a substrate having an insulating surface.

4.3 However, in the same field of active-matrix devices, D2 discloses forming gate electrodes on a substrate having a conductive layer including a refractory metal (Ti) by ink jet method to simplify the manufacturing of a TFT array (see at least paragraph 12).

4.4 At the time the invention was made, it would have been obvious to a person having ordinary skill in the art having the references of D1-D2 to modify the device of D1 to include the conductive layer with a refractory metal of D2 in order to simplify TFT.

Response to Arguments

4.5 Applicant's arguments filed 09/09/2009 have been fully considered but they are not persuasive.

4.6 Applicant argues that Takao does not disclose that the gate electrode is on the base film because, in FIGS. 9 and 10 of Takao, the gate electrode 26 is not on a substrate having a photocatalytic surface (TiO₂).

4.7 Examiner disagrees. The gate electrode may not be in direct contact with the quartz glass substrate having the photocatalytic surface, but the gate electrode is on the substrate. Takao therefore discloses the limitations of claims 1, 2, 3, 4, 14, 15, 16, and 17.

4.8 Applicant also argues that Takao fails to disclose a refractory metal, not only "Ti (titanium)" but also other metal. Moreover, Takao does not teach or suggest the possibility of substrate having a conductive layer including a refractory metal (Ti) nor the motivation to use refractory metal for conductive layer within the written description.

Art Unit: 2889

49 Examiner disagrees. Ti is a refractory metal that is on the surface of the insulating substrate. The motivation to use a refractory metal as taught by Takao is to simplify the manufacture of the display (see paragraph 112). Furthermore, Takao teach that metals such as Pt, Pd, or Au can be doped into the TiO₂ layer in paragraph 41. Therefore, Takao disclose the limitations of claims 6, 7, 8, 9, 19, 20, 21, and 22.

Conclusion

50 Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

51 A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

52 Any inquiry concerning this communication or earlier communications from the examiner should be directed to Britt Hanley whose telephone number is (571) 270-3042. The examiner can normally be reached on Monday - Thursday, 6:30a-5:00p ET.

53 If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Minh-Toan Ton can be reached on (571)272-2303. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

54 Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Art Unit: 2889

/Britt Hanley/
Examiner, Art Unit 2889

/Toan Ton/
Supervisory Patent Examiner, Art Unit 2889